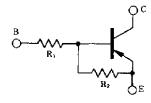


AP1 SERIES

on-chip resistor NPN silicon epitaxial transistor For mid-speed switching

FEATURES

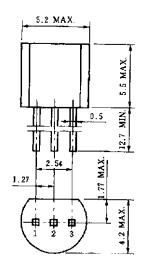
- · Current drive available up to 0.7 A
- On-chip bias resistor
- · Low power consumption during drive



AP1 SERIES LISTS

Products	R ₁ (KΩ)	R ₂ (KΩ)
AP1A4A	-	10
AP1L2Q	0.47	4.7
AP1A3M	1.0	1.0
AP1F3P	2.2	10
AP1J3P	3.3	10
AP1L3N	4.7	10
AP1A4M	10	10

PACKAGE DRAWING (UNIT: mm)



Electrode Connection

Emitter EIAJ : SC-43B
 Collector JEDEC: TO-92
 Base IEC : PA33

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	Vсво	-25	V
Collector to emitter voltage	Vceo	-25	V
Emitter to base voltage	V _{EBO}	-10	V
Collector current (DC)	Ic(DC)	-0.7	Α
Collector current (Pulse)	Ic(pulse) *	-1.0	Α
Base current (DC)	I _{B(DC)}	-0.02	Α
Total power dissipation	Рт	750	mW
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

^{*} PW \leq 10 ms, duty cycle \leq 50 %

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AP1A4A ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	$V_{CB} = -22 \text{ V}, I_E = 0$			100	nA
DC current gain	h _{FE1} **	$V_{CE} = -2.0 \text{ V}, I_{C} = -0.1 \text{ A}$	200			-
DC current gain	h _{FE2} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	100			-
DC current gain	h _{FE3} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.7 \text{ A}$	50			_
Collector saturation voltage	VCE(sat) **	Ic = -0.3 A, Ic = -6 A		-0.28	-0.4	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R ₁		-	-	-	Ω
E-to-B resistance	R ₂		7	10	13	kΩ

^{**} PW \leq 350 μ s, duty cycle \leq 2 %

AP1L2Q ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = -22 V, IE = 0			-100	nA
DC current gain	h _{FE1} **	Vce = -2.0 V, Ic = -0.1 A	150	350		-
DC current gain	h _{FE2} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	100	300		-
DC current gain	h _{FE3} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.7 \text{ A}$	50	200		_
Low level output voltage	V OL **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.3 \text{ A}$		-0.3	-0.4	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$		-0.65	-0.3	V
Input resistance	R ₁		329	470	611	Ω
E-to-B resistance	R ₂		3.39	4.7	6.11	kΩ

^{**} PW \leq 350 μ s, duty cycle \leq 2 %

AP1A3M ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	V _{CB} = -22 V, I _E = 0			100	nA
DC current gain	h _{FE1} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	80			ı
DC current gain	h _{FE2} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	100			-
DC current gain	hFE3 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.7 \text{ A}$	50			-
Low level output voltage	Vol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.2 \text{ A}$		-0.3	-0.4	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R ₁		0.7	1.0	1.3	kΩ
E-to-B resistance	R ₂		0.7	1.0	1.3	kΩ

^{**} PW \leq 350 μ s, duty cycle \leq 2 %



AP1F3P ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = -22 V, IE = 0			-100	nA
DC current gain	h _{FE1} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	200	470		_
DC current gain	h _{FE2} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	100	300		_
DC current gain	h _{FE3} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.7 \text{ A}$	50	200		-
Low level output voltage	V ol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.2 \text{ A}$		-0.2	-0.4	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$		-0.65	-0.3	V
Input resistance	R ₁		2.3	3.3	4.3	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ

^{**} PW \leq 350 μ s, duty cycle \leq 2 %

AP1J3P ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = -22 V, IE = 0			100	nA
DC current gain	h _{FE1} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	300	600		-
DC current gain	hFE2 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	300	700		_
DC current gain	h _{FE3} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.7 \text{ A}$	135	600		_
Low level output voltage	V ol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.15 \text{ A}$		0.14	0.3	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			0.3	V
Input resistance	R ₁		2.31	3.3	4.29	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ

^{**} PW \leq 350 μ s, duty cycle \leq 2 %

AP1L3N ELECTRICAL CHARACTERISTICS (Ta = 25°C)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = -22 V, IE = 0			-100	nA
DC current gain	h _{FE1} **	Vce = -2.0 V, Ic = -0.1 A	200			-
DC current gain	hFE2 **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	100			-
DC current gain	h _{FE3} **	Vce = -2.0 V, Ic = -0.7 A	50			-
Low level output voltage	V ol **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.15 \text{ A}$			-0.45	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R₁		3.29	4.7	6.11	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ

^{**} PW \leq 350 μ s, duty cycle \leq 2 %

Data Sheet D16171EJ1V0DS



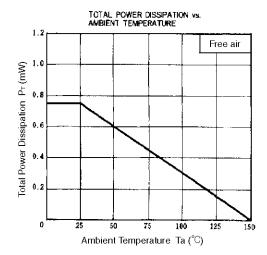
AP1A4M ELECTRICAL CHARACTERISTICS (Ta = 25°C)

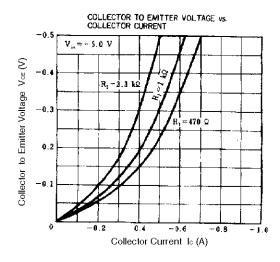
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = -22 V, IE = 0			-100	nA
DC current gain	h _{FE1} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$	200			-
DC current gain	h _{FE2} **	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -0.5 \text{ A}$	100			-
DC current gain	h _{FE3} **	$V_{CE} = -2.0 \text{ V}, I_{C} = -0.7 \text{ A}$	50			-
Low level output voltage	V OL **	$V_{IN} = -5.0 \text{ V}, \text{ Ic} = -0.1 \text{ A}$			-0.4	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$			-0.3	V
Input resistance	R ₁		7	10	13	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ

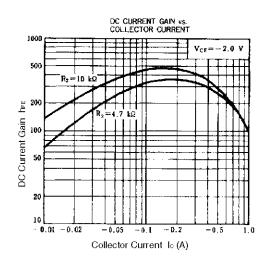
^{**} PW \leq 350 μ s, duty cycle \leq 2 %

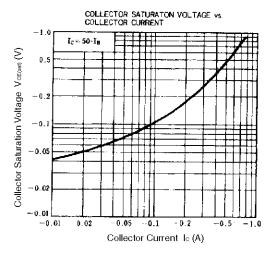


TYPICAL CHARACTERISTICS (Ta = 25°C)









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